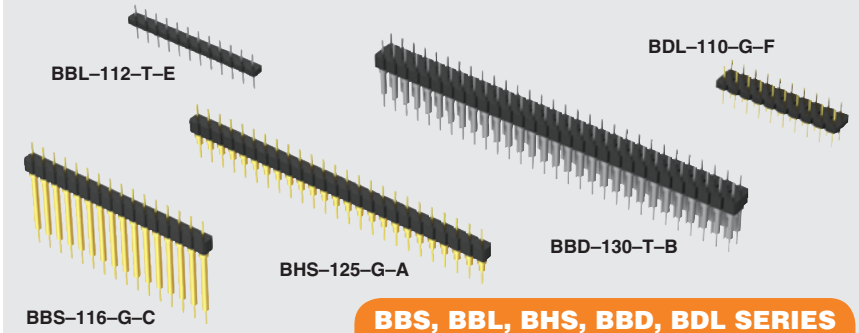


(2,54 mm) .100"

BBS, BBL, BHS, BBD, BDL SERIES

MACHINED BOARD STACKING STRIPS

Mates with:
SS, SD, HSS, SL, SDL, ESS, ESD

FEATURES

- Low profile design achieves (3,89 mm) .153" board spacings when mated with SL Series.
- Approach the reliability of a permanent connection with the flexibility of a separable connection.

SPECIFICATIONS

For complete specifications see www.samtec.com?BBS, www.samtec.com?BBL, www.samtec.com?BHS www.samtec.com?BBD or www.samtec.com?BDL

Insulator Material:
Black Glass Filled Polyester (BBS, BBD, BBL)
Black High Temp Nylon (BDL)
Black Liquid Crystal Polymer (BHS)
Temperature Range:
-55°C to +125°C
Terminal Material:
Phosphor Bronze or Brass
Plating:
Au or Sn over 50µ" (1,27 µm) Ni
RoHS Compliant:
Yes
Lead-Free Solderable:
Wave only (BBS, BBD, BBL, BDL)
Wave, or reflow with all Au (BHS)

RECOGNITIONS

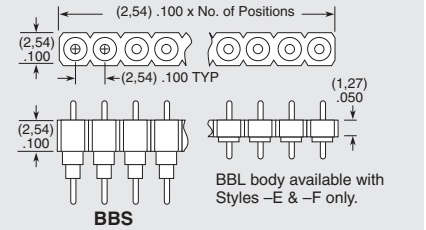
For complete scope of recognitions see www.samtec.com/quality

FILE NO. E111594

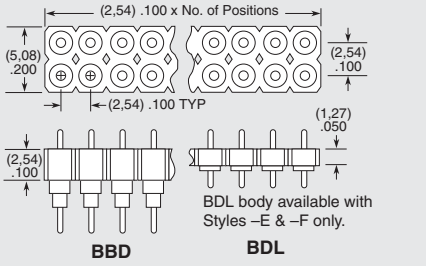
Note: Some lengths, styles and options are non-standard, non-returnable.

TYPE STRIP – **1** – **NO. PINS PER ROW** – **PLATING OPTION** – **LEAD STYLE**

BBS = Standard Single Row
BBL = Low Profile Single Row
BHS = High Temp Single Row



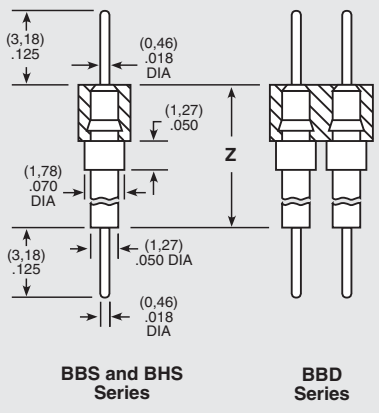
BBD = Standard Double Row
BDL = Low Profile Double Row

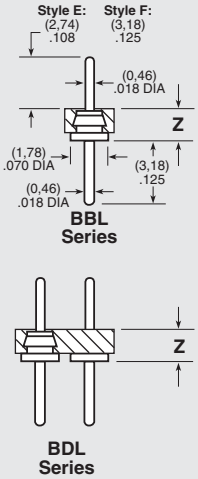


–G =20 µ" (0,51 µm) Gold
–T =Tin

01 thru 32 =BBS & BBL
01 thru 36 =BBD, BDL & BHS

–A Z = (5,33 mm) .210"
–B Z = (8,51 mm) .335"
–C Z = (14,86 mm) .585"
–E Z = (1,78 mm) .070"
–F Z = (2,16 mm) .085"





Due to technical progress, all designs, specifications and components are subject to change without notice.